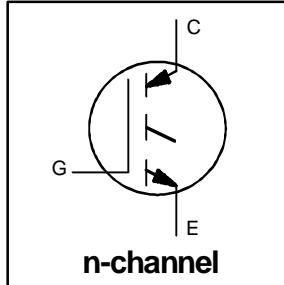


Features

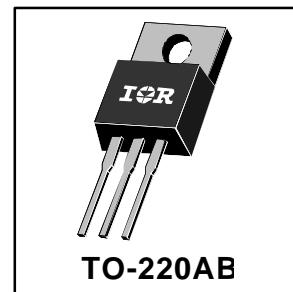
- Switching-loss rating includes all "tail" losses
- Optimized for high operating frequency (over 5kHz)
- See Fig. 1 for Current vs. Frequency curve



$V_{CES} = 500V$
$V_{CE(sat)} \leq 3.0V$
@ $V_{GE} = 15V, I_C = 7.5A$

Description

Insulated Gate Bipolar Transistors (IGBTs) from International Rectifier have higher usable current densities than comparable bipolar transistors, while at the same time having simpler gate-drive requirements of the familiar power MOSFET. They provide substantial benefits to a host of high-voltage, high-current applications.



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Voltage	500	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	14	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	7.5	
I_{CM}	Pulsed Collector Current ①	28	
I_{LM}	Clamped Inductive Load Current ②	28	
V_{GE}	Gate-to-Emitter Voltage	± 20	V
E_{ARV}	Reverse Voltage Avalanche Energy ③	5.0	mJ
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	60	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	24	
T_J	Operating Junction and	-55 to $+150$	$^\circ C$
T_{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	
	Mounting torque, 6-32 or M3 screw.	10 lbf•in (1.1N•m)	

Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	—	2.1	$^\circ C/W$
$R_{\theta CS}$	Case-to-Sink, flat, greased surface	—	0.50	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	—	80	
Wt	Weight	—	2.0 (0.07)	—	g (oz)

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)CES}$	Collector-to-Emitter Breakdown Voltage	500	—	—	V	$V_{GE} = 0V, I_C = 250\mu\text{A}$
$V_{(BR)ECS}$	Emitter-to-Collector Breakdown Voltage ④	20	—	—	V	$V_{GE} = 0V, I_C = 1.0\text{A}$
$\Delta V_{(BR)CES}/\Delta T_J$	Temp. Coeff. of Breakdown Voltage	—	0.47	—	$\text{V}/^\circ\text{C}$	$V_{GE} = 0V, I_C = 1.0\text{mA}$
$V_{CE(on)}$	Collector-to-Emitter Saturation Voltage	—	2.4	3.0	V	$I_C = 7.5\text{A}$
		—	3.1	—		$I_C = 14\text{A}$
		—	2.7	—		$I_C = 7.5\text{A}, T_J = 150^\circ\text{C}$
$V_{GE(\text{th})}$	Gate Threshold Voltage	3.0	—	5.5		$V_{CE} = V_{GE}, I_C = 250\mu\text{A}$
$\Delta V_{GE(\text{th})}/\Delta T_J$	Temperature Coeff. of Threshold Voltage	—	-10	—	$\text{mV}/^\circ\text{C}$	$V_{CE} = V_{GE}, I_C = 250\mu\text{A}$
g_{fe}	Forward Transconductance ⑤	1.2	2.0	—	S	$V_{CE} = 100V, I_C = 7.5\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	250	μA	$V_{GE} = 0V, V_{CE} = 500V$
		—	—	1000		$V_{GE} = 0V, V_{CE} = 500V, T_J = 150^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{GE} = \pm 20V$

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge (turn-on)	—	15	23	nC	$I_C = 7.5\text{A}$
Q_{ge}	Gate - Emitter Charge (turn-on)	—	3.7	5.6		$V_{CC} = 400V$
Q_{gc}	Gate - Collector Charge (turn-on)	—	6.5	9.8		$V_{GE} = 15V$
$t_{d(on)}$	Turn-On Delay Time	—	28	—	ns	$T_J = 25^\circ\text{C}$
t_r	Rise Time	—	11	—		$I_C = 7.5\text{A}, V_{CC} = 400V$
$t_{d(off)}$	Turn-Off Delay Time	—	72	110		$V_{GE} = 15V, R_G = 50\Omega$
t_f	Fall Time	—	96	140		Energy losses include "tail"
E_{on}	Turn-On Switching Loss	—	0.13	—	mJ	See Fig. 9, 10, 11, 14
E_{off}	Turn-Off Switching Loss	—	0.08	—		
E_{ts}	Total Switching Loss	—	0.21	0.28		
$t_{d(on)}$	Turn-On Delay Time	—	26	—	ns	$T_J = 150^\circ\text{C}, I_C = 7.5\text{A}, V_{CC} = 400V$
t_r	Rise Time	—	12	—		$V_{GE} = 15V, R_G = 50\Omega$
$t_{d(off)}$	Turn-Off Delay Time	—	120	—		Energy losses include "tail"
t_f	Fall Time	—	140	—		See Fig. 10, 14
E_{ts}	Total Switching Loss	—	0.35	—	mJ	
L_E	Internal Emitter Inductance	—	7.5	—	nH	Measured 5mm from package
C_{ies}	Input Capacitance	—	330	—	pF	$V_{GE} = 0V$
C_{oes}	Output Capacitance	—	47	—		$V_{CC} = 30V$
C_{res}	Reverse Transfer Capacitance	—	5.9	—		See Fig. 7 $f = 1.0\text{MHz}$

Notes:

① Repetitive rating; $V_{GE}=20V$, pulse width limited by max. junction temperature.
(See fig. 13b)

② $V_{CC}=80\%(V_{CES})$, $V_{GE}=20V$, $L=10\mu\text{H}$, $R_G=50\Omega$, (See fig. 13a)

③ Repetitive rating; pulse width limited by maximum junction temperature.

④ Pulse width $\leq 80\mu\text{s}$; duty factor $\leq 0.1\%$.

⑤ Pulse width $5.0\mu\text{s}$, single shot.

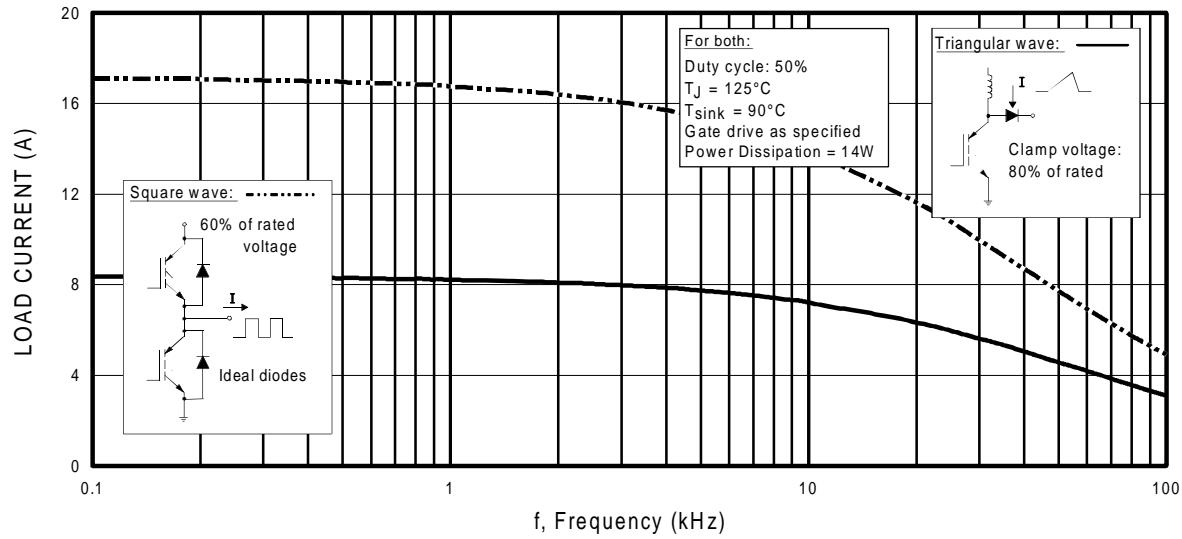


Fig. 1 - Typical Load Current vs. Frequency
(For square wave, $I=I_{RMS}$ of fundamental; for triangular wave, $I=I_{PK}$)

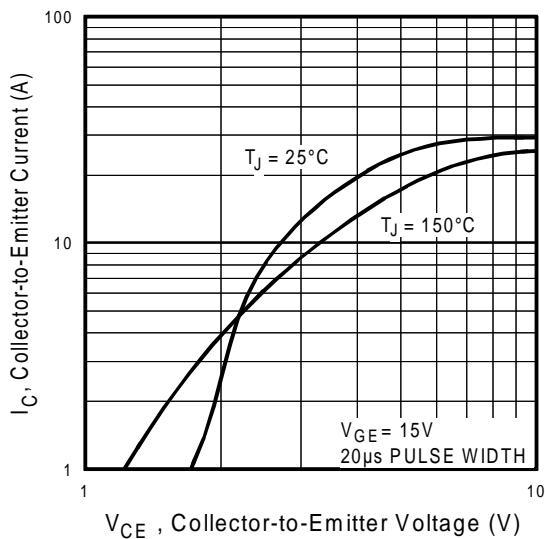


Fig. 2 - Typical Output Characteristics

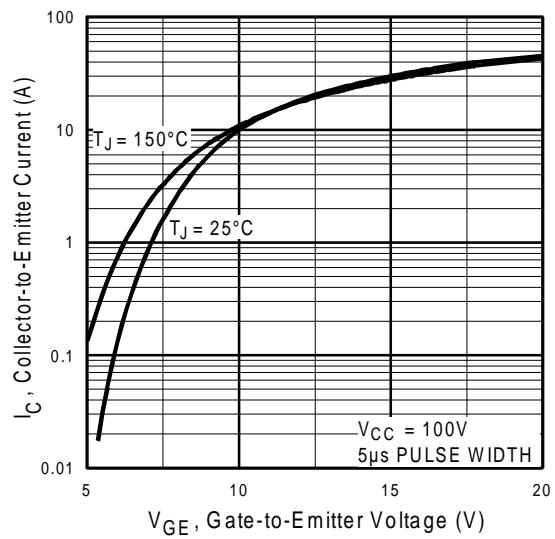


Fig. 3 - Typical Transfer Characteristics

IRGB420U

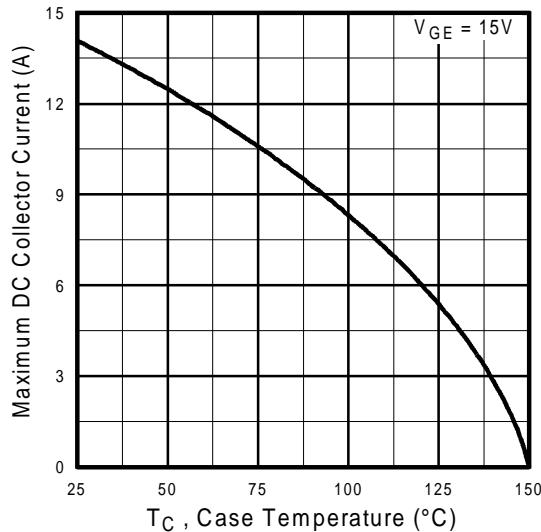


Fig. 4 - Maximum Collector Current vs. Case Temperature

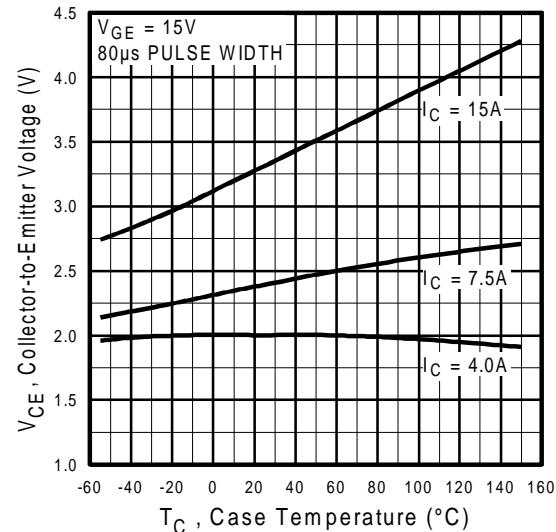


Fig. 5 - Collector-to-Emitter Voltage vs. Case Temperature

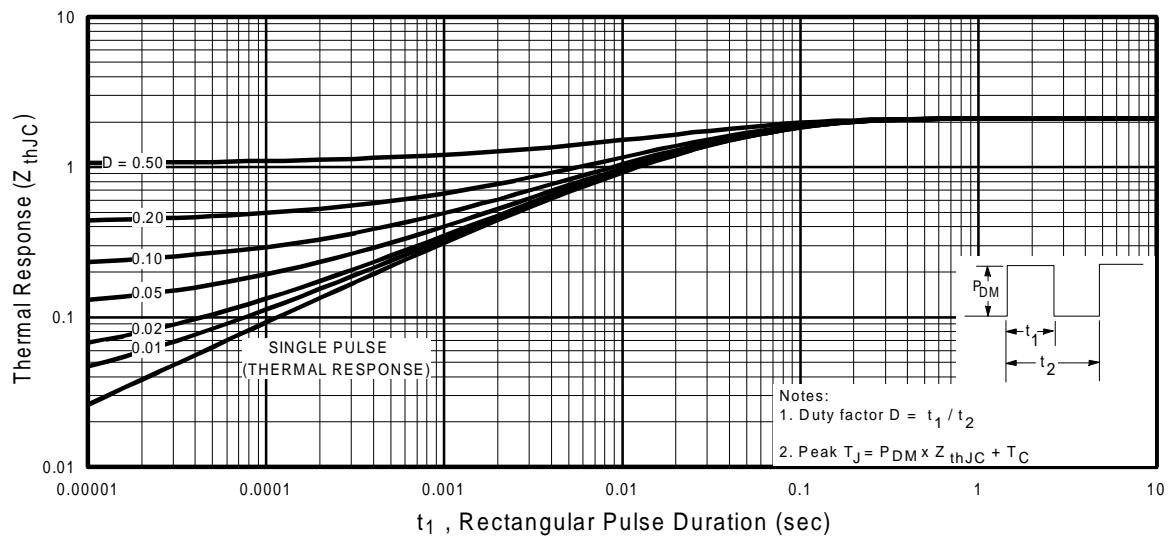
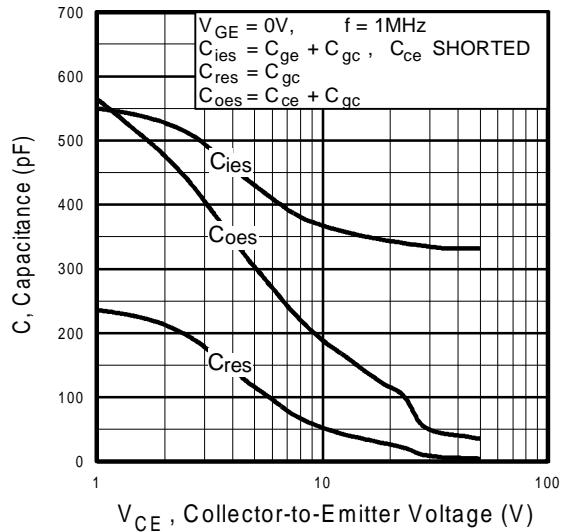
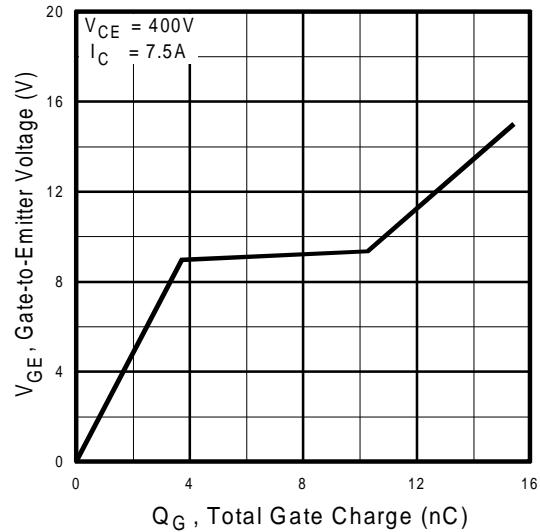


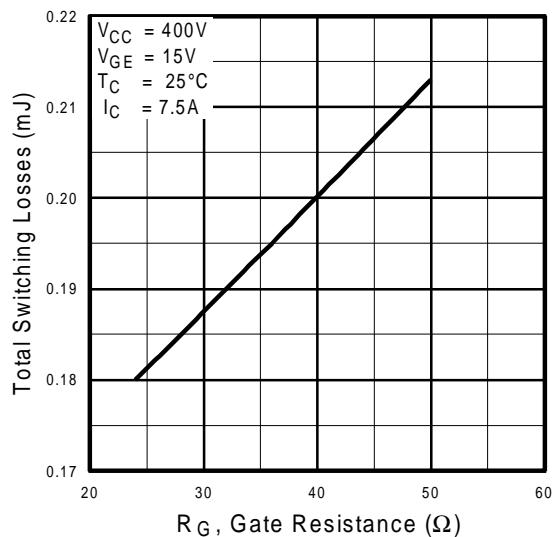
Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



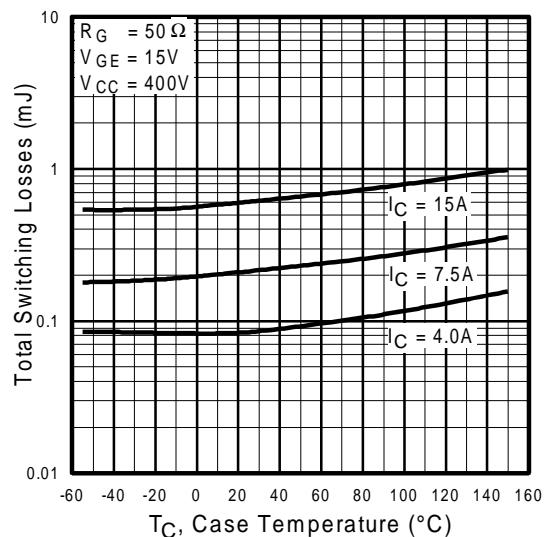
**Fig. 7 - Typical Capacitance vs.
Collector-to-Emitter Voltage**



**Fig. 8 - Typical Gate Charge vs.
Gate-to-Emitter Voltage**



**Fig. 9 - Typical Switching Losses vs. Gate
Resistance**



**Fig. 10 - Typical Switching Losses vs.
Case Temperature**

IRGB420U

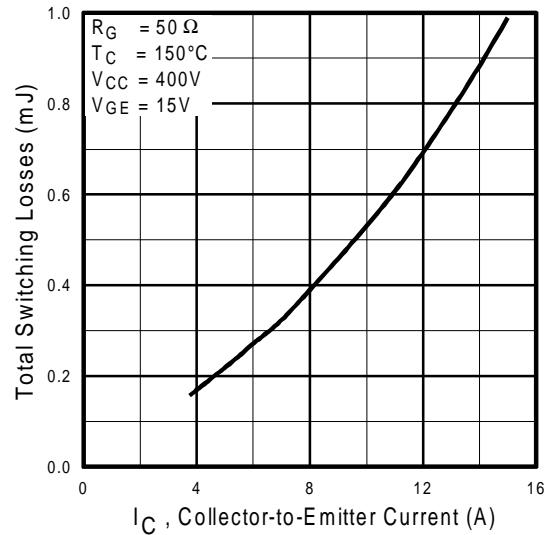


Fig. 11 - Typical Switching Losses vs.
Collector-to-Emitter Current

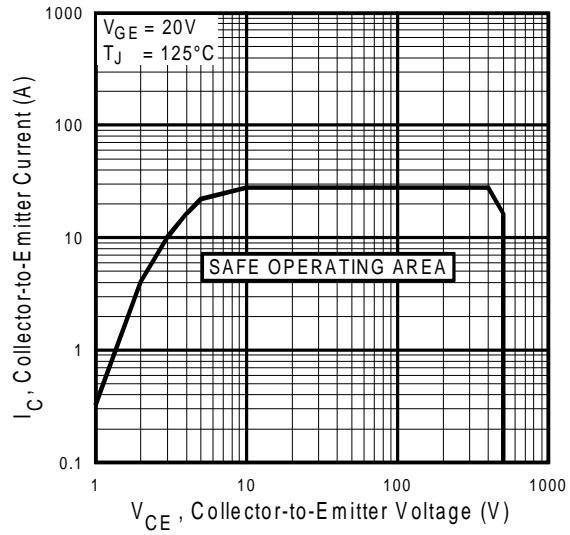


Fig. 12 - Turn-Off SOA

Refer to Section D for the following:

Appendix A: Section D - page D-3

- Fig. 13a - Clamped Inductive Load Test Circuit
- Fig. 13b - Pulsed Collector Current Test Circuit
- Fig. 14a - Switching Loss Test Circuit
- Fig. 14b - Switching Loss Waveform

Package Outline 1 - JEDEC Outline TO-220AB

Section D - page D-12